PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Byung Choon LEE	12/17/2007
Tae Uk KIM	12/17/2007

RECEIVING PARTY DATA

Name:	Cheil Industries Inc.
Street Address:	290 Gongdan-dong
Internal Address:	Gumi-si
City:	Gyeongsangbuk-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	730-710

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11958486

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	1224.011

NAME OF SUBMITTER: Melissa B. Pendleton

Total Attachments: 4

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ASSIGNMENT

WHEREAS, I, Byung Choon LEE, a Korean citizen, residing at 265-386, Hongeun 3-dong, Seodaemun-gu, Secul, Republic of Korea; and Tae Uk KIM, a Korean citizen, residing at \$107-504, Jowon Jugong Apt., Jowon-dong, Jangan-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in Polycarbonate Resin Composition and Flastic Article, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from a Korean Patent Application filed on December 29, 2006, under Ser. No. 2006-0138341, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors

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and assigns, my equitable right, title, and interest and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest-in and to said invention and APPLICATION, in and to any and all continuations. continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said

INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

10. December, 2007 Dyung Choon LEE

10. December, 2007 Tae UK KIM

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